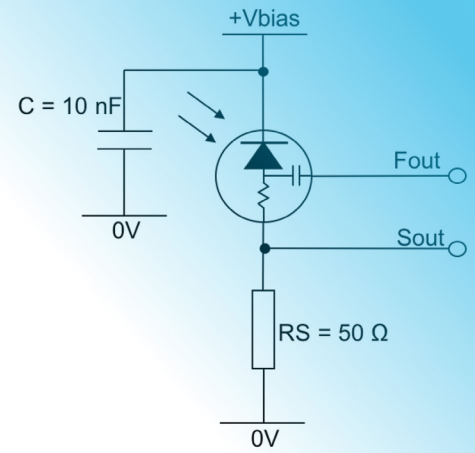


Biasing & Readout

TECH NOTE



Biasing and Readout of SensL SiPM Sensors

This technical note covers all aspects of Silicon Photomultiplier (SiPM) biasing and readout for SensL SiPMs. Readout options for both the *standard* and *fast* terminals are discussed.

1. SiPM Structure

The SiPM consists of an array of microcells. Each microcell consists of a Single Photon Avalanche Diode (SPAD) and a quench resistor. SensL SiPMs have 3 terminals; *cathode*, *anode* and *fast output*. For further details of SiPM technology please refer the [Introduction to SiPM](#) tech note. The SiPM circuit structure and circuit schematic symbol are shown in Figure 1.

SensL SiPMs are either P-on-N or N-on-P type diode structures. Figure 2 shows the diode structure and Figure 3 shows the SiPM schematics for both types.

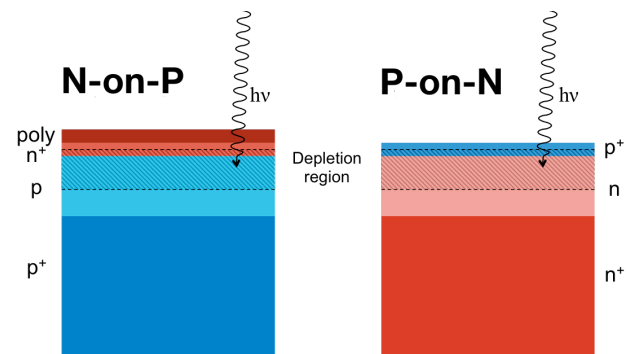


Figure 2, N-on-P and P-on-N diode structures.

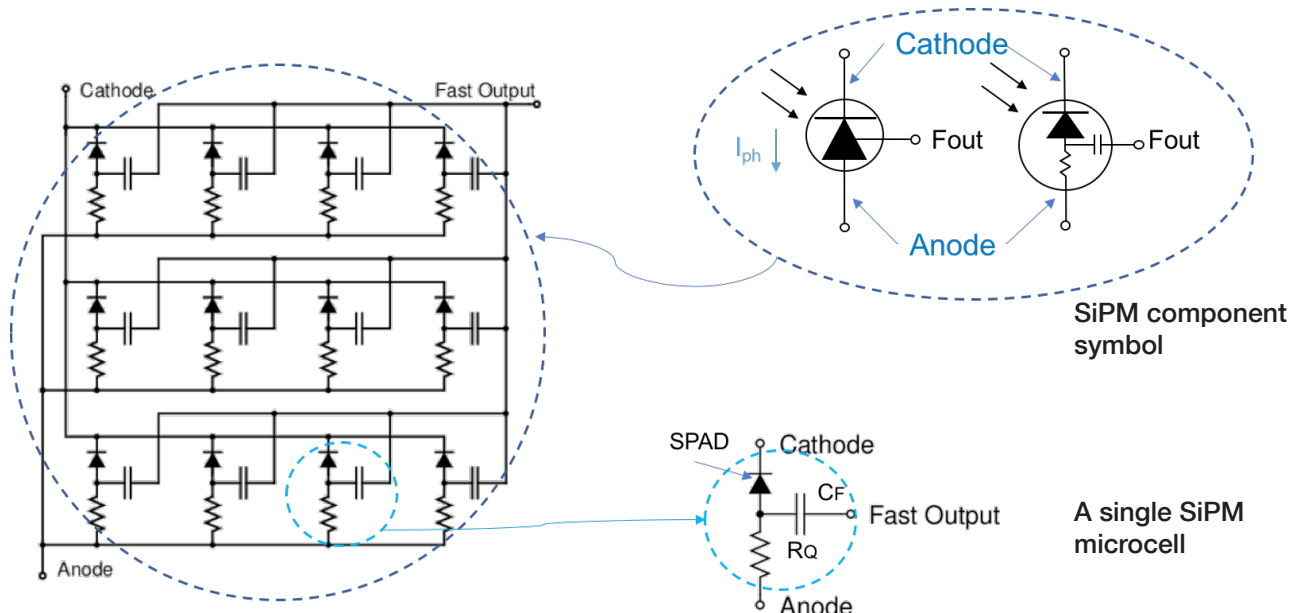


Figure 1, SiPM internal structure and component symbol. The SiPM consists of an array of microcells connected in parallel. Each microcell features a SPAD, quench resistor R_q and fast capacitor C_f .

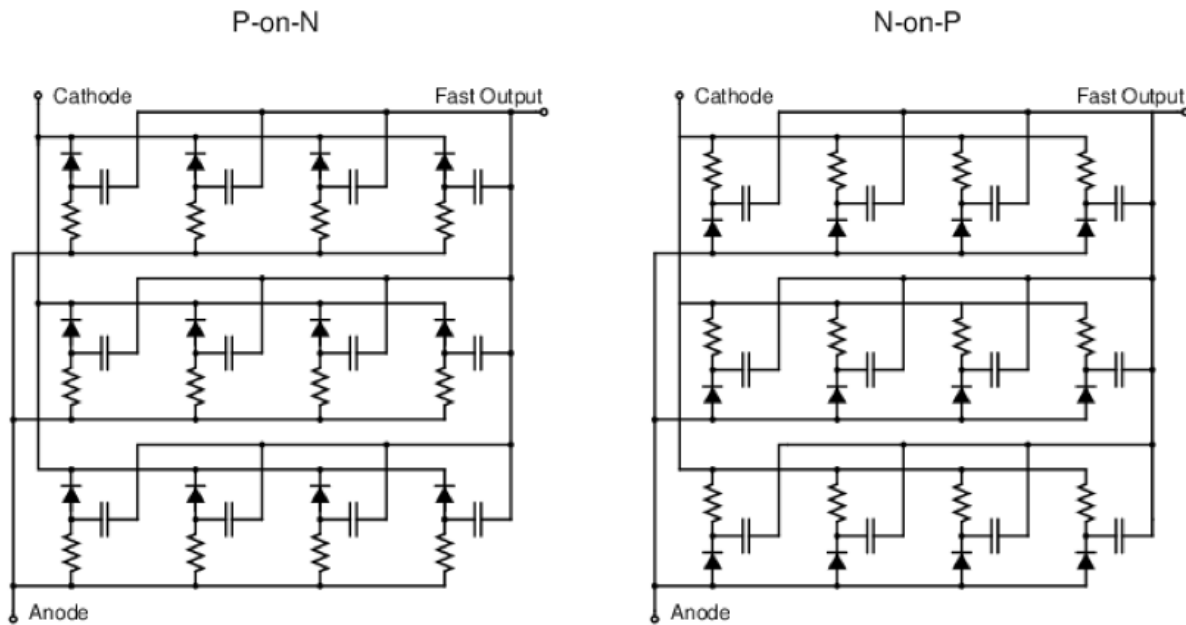


Figure 3, Schematic differences of N-on-P and P-on-N SiPM structures.

P-on-N structures are used for blue-sensitive SiPMs (C-Series, J-Series) while an N-on-P structure creates a more red-sensitive SiPMs (R-Series).

2. Biasing the SiPM

The SiPM is designed to operate in Geiger mode where the *cathode* must be positively biased with respect to the *anode* above the breakdown voltage, as per figure 4. The breakdown voltage of the SiPM is the minimum reverse bias voltage at which the SPAD operates in Geiger or avalanche mode. The overvoltage is the excess applied bias above the breakdown voltage.

Breakdown voltage and overvoltage range are both a function of the particular SiPM technology. The applied bias voltage should be guided by the datasheet specification for the SiPM, noting that the overvoltage influences SiPM parameters such as PDE (photon detection efficiency), gain and noise.

SiPM breakdown voltage is temperature dependent. The temperature coefficient of breakdown voltage is process dependent and given in the product datasheet. For accurate quantitative detection in an uncontrolled thermal environment, temperature measurement and

compensation of the bias voltage may be required to maintain a consistent overvoltage and performance.

2.1. Output Polarity

The *standard output* polarity depends on whether the *anode* or the *cathode* is being used for readout and does not depend on the sensor type. Reading out from the *cathode* will give a negative polarity and reading out from the *anode* will produce positive polarity.

The polarity of the *fast output* is determined by the sensor type. The *fast output* polarity is always positive for P-on-N sensors and negative for N-on-P sensor types. Examples of biasing options are shown in Figures 5 - 8 on the following pages.

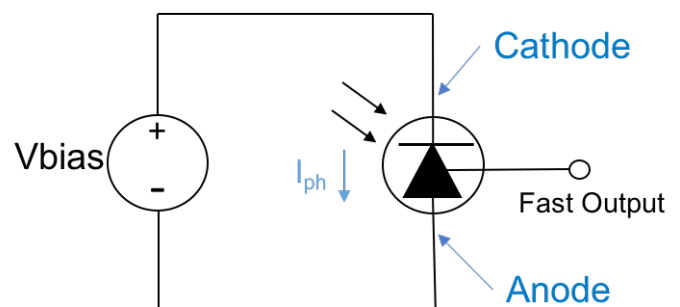


Figure 4, Biasing the SiPM.

2.2. P-on-N SiPM Structure

The best *fast output* timing and pulse amplitude can be achieved with circuits A or B. If using the *fast output* in circuit B, then a 10 nF, 100 V, low ESR decoupling capacitor must be connected between the *cathode* and 0 V. The track length from the *cathode* to the capacitor should be minimized to reduce track inductance.

Circuit configurations C and D will result in less optimal *fast output* timing and amplitude but will still provide good performance otherwise.

For all circuits, the sense resistor, R_S , sets up a voltage output on *Sout*. To minimize the microcell recovery time, the series resistance can be $R_S = 0 \Omega$. However in this scenario only the *fast output* is available.

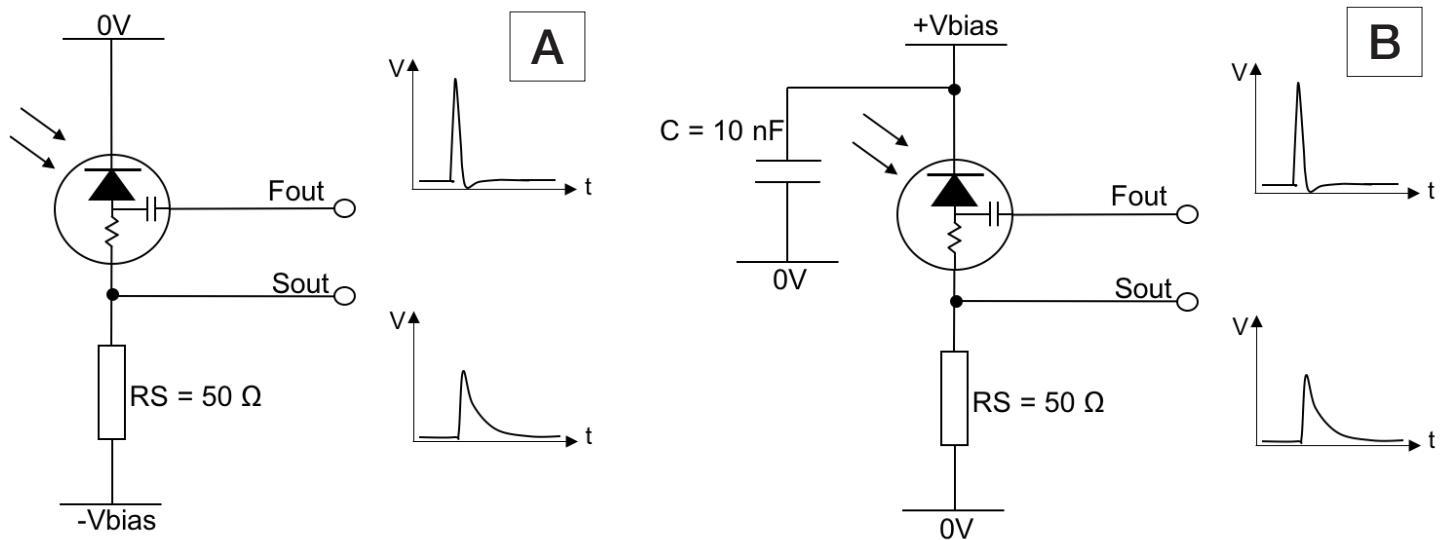


Figure 5, Biasing and readout circuits A and B, for C-Series and J-Series products. These configurations give the best fast output timing performance. Note that the fast output is always referenced to 0V. *Sout* is referred to -Vbias in A and to 0V in B.

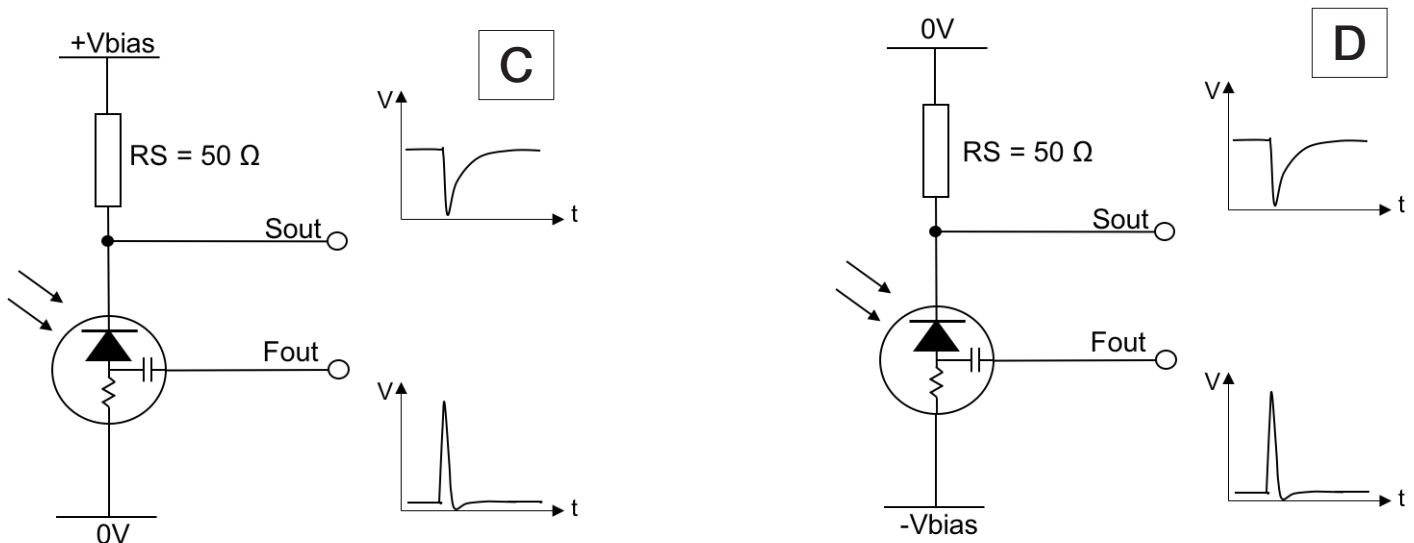


Figure 6, Biasing circuits C and D, for C-Series and J-Series products. These configurations give less optimum fast output timing performance compared to A and B. Note that the fast output is always referenced to 0V. *Sout* is referred to +Vbias in C and to 0V in D.

2.3. N-on-P SiPM Structure

The best *fast output* timing and pulse amplitude can be achieved with circuits E or F. If using the *fast output* in circuit F, then a 10 nF, 100 V, low ESR decoupling capacitor must be connected between the *anode* and 0 V. The track length from the *cathode* to the capacitor should be minimized to reduce track inductance

Circuit configurations G and H will result in less optimal *fast output* timing and amplitude but will still provide good performance otherwise.

For all circuits, the sense resistor, R_S , sets up a voltage output on S_{out} . To minimize the microcell recovery time, the series resistance can be $R_S = 0 \Omega$. However in this scenario only the *fast output* is available.

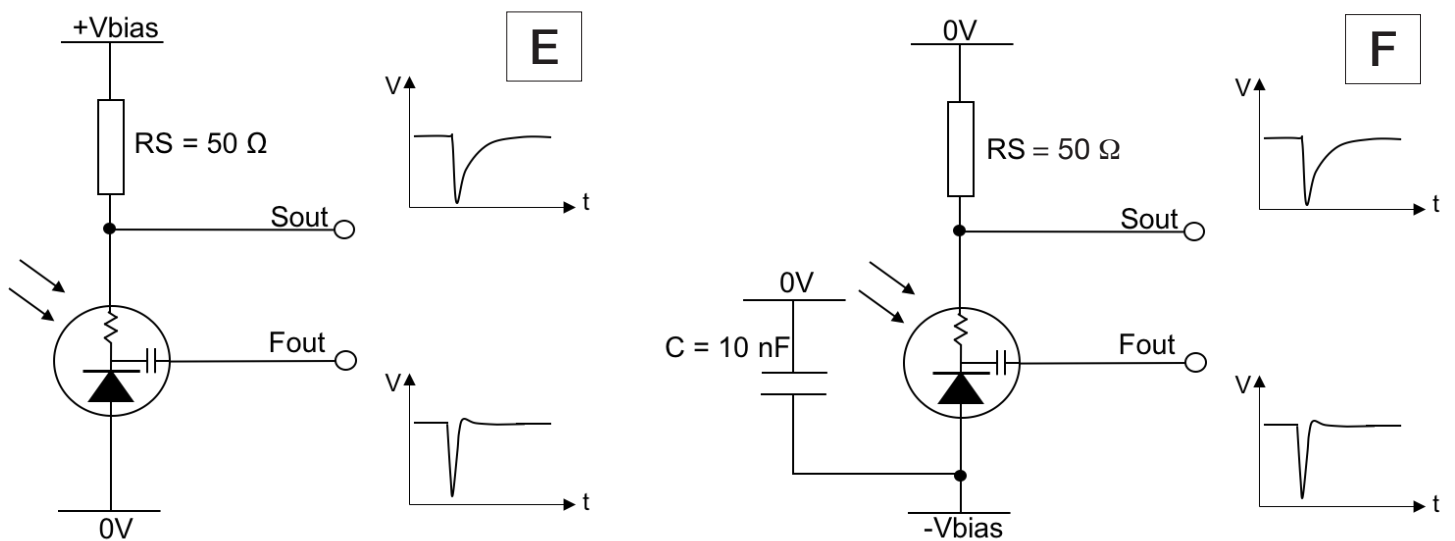


Figure 7, Biasing and readout circuits E and F, for R-Series products. These configurations give the best fast output timing performance. Note that the fast output is always referenced to 0V. S_{out} is referred to $+V_{bias}$ in E and to 0V in F.

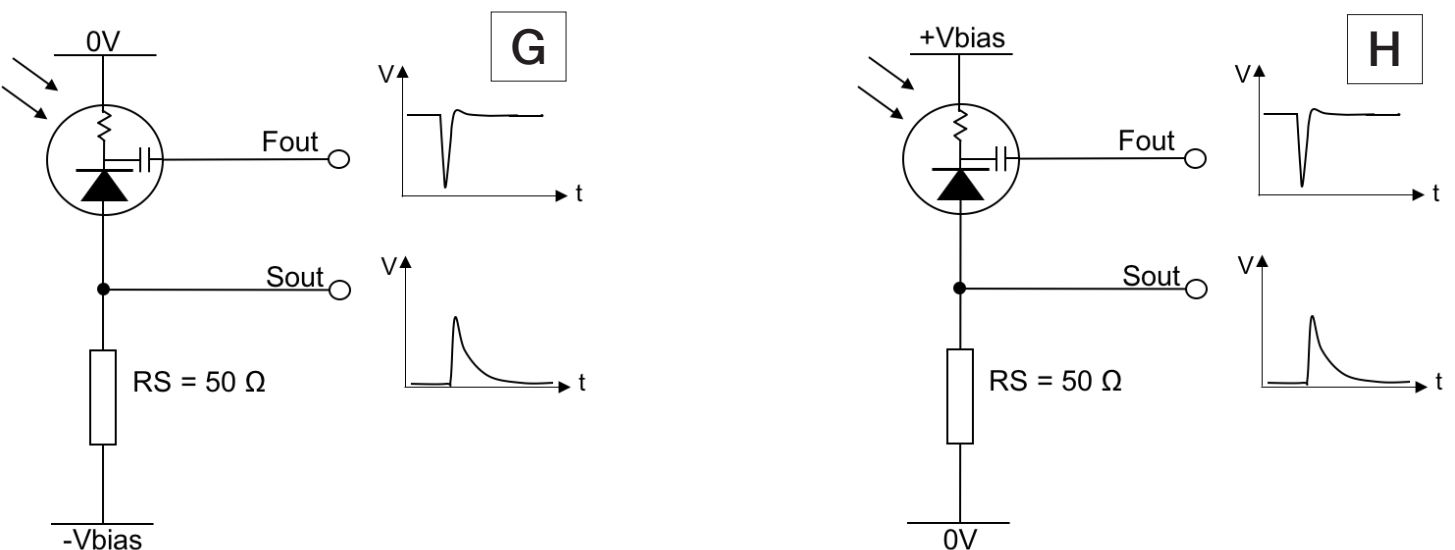


Figure 8, Biasing circuits G and H, for R-Series products. These configurations give less optimum fast output timing performance compared to E and F. Note that the fast output is always referenced to 0V. S_{out} is referred to 0V in G and to $+V_{bias}$ in H.

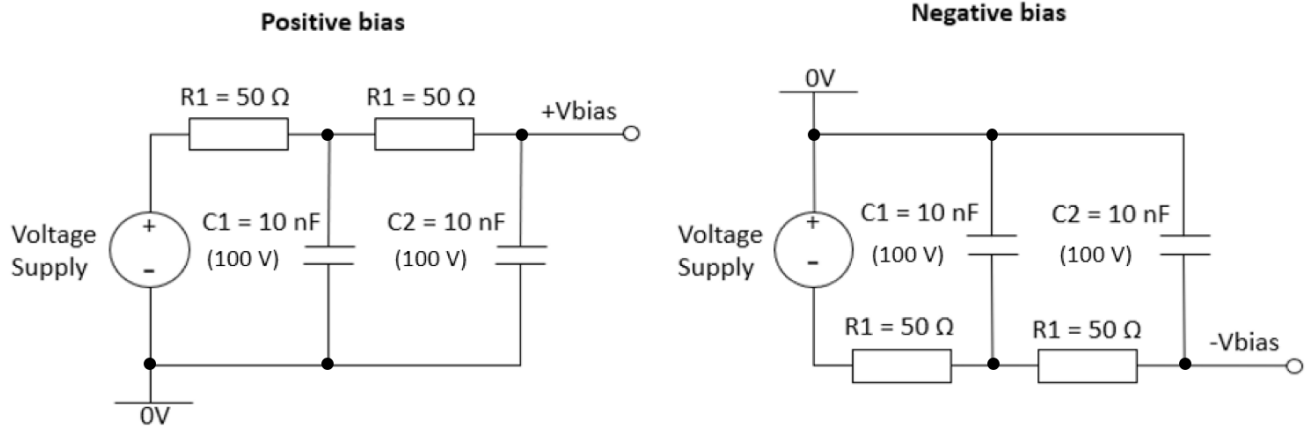


Figure 9, SensL generic bias filter.

2.4. Bias Filter

A bias filter such as that in Figure 9 may be used with the SiPM to help supply a stable bias voltage by filtering out any noise that may come from the power supply. The components used may be varied to suit the intended application if a specific cut-off frequency is required. This filter is recommended for applications using noisy or switched power supplies. However, the filter may not be suitable for applications requiring fast recovery time or high dynamic range as the series resistance will increase recovery times. For this reason, the values of $R1$ and $R2$ should be kept small. Please see the [Optimizing Recovery Time](#) section for more details.

2.5. Bias Decoupling

When a light pulse is detected by the SiPM it will draw a fast transient current from the bias supply which can cause the supply voltage to drop slightly for a short period of time. A decoupling capacitor acts as a charge storage device providing energy when required by the SiPM and making it less susceptible to short term changes in the bias voltage. Changes in the bias voltage are effectively changes to the applied overvoltage which controls the gain and PDE of the SiPM. The capacitance of the selected decoupling capacitor should be greater than the capacitance of the SiPM being used. To maintain a consistent bias supply it is recommended that a good quality, 10 nF, 100 V, ceramic SMT decoupling capacitor, with low ESR and ESL, be connected between V_{bias} and 0 V, as close to the SiPM V_{bias} terminal (*anode or cathode*) as possible. See Figure 10.

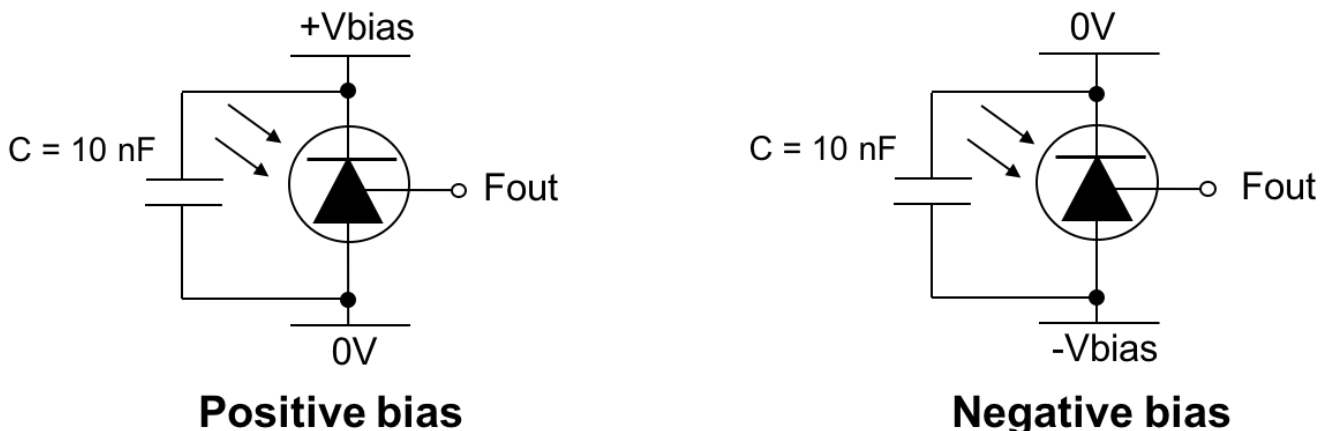


Figure 10, Decoupling of the bias.

3. Basic SiPM Readout

When biased in Geiger mode, the SiPM produces a photocurrent proportional to the number of microcells that have fired, which provides a measure of the amount of light detected by the sensor. The photocurrent (I_{ph}) flows through the sensor from *cathode* to *anode*, as shown in Figure 11, and either of these terminals may be used as the *standard output*.

The *fast output* is a capacitively coupled output derived from the fast switching pulse that occurs within the microcell. Unlike the *standard output* there is no net charge transfer across the *fast output*. The *fast output* amplitude is proportional to the number of microcells that have fired and can therefore provide information on the number of photons detected. The *fast output* is AC coupled and does not provide any DC information.

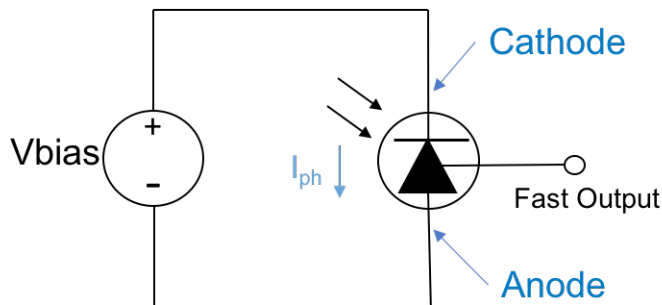


Figure 11, Photocurrent in the SiPM

Both the *standard* and *fast outputs* can be used alone or together and either can be used for amplitude or timing measurements. Using both outputs simultaneously is possible and this enables measuring of timing and charge via separate circuits.

If the *fast output* is not used it should be left floating without any cables or wires attached. If the *standard output* is not required simply connect the bias supply directly across the SiPM as in Figure 11.

3.1. Standard Output Readout

To read out the SiPM from the *standard output*, the photocurrent generated on detection of photons needs to be converted to a voltage. This can be achieved using a transimpedance amplifier (TIA) as depicted in Figure 12 or using a series resistor as shown in Figure 13. Either *cathode* or *anode* may be used as the *standard output* in both cases.

When detecting low power optical signals, amplification of the *standard output* may be required. When using a TIA the transimpedance gain is equal to the value of the feedback resistor, R_F .

If a series resistor is used, then the transimpedance gain is set by the series resistor, R_s .

More than one amplifier stage may be required to provide sufficient gain. A low noise 50 Ω voltage amplifier with a

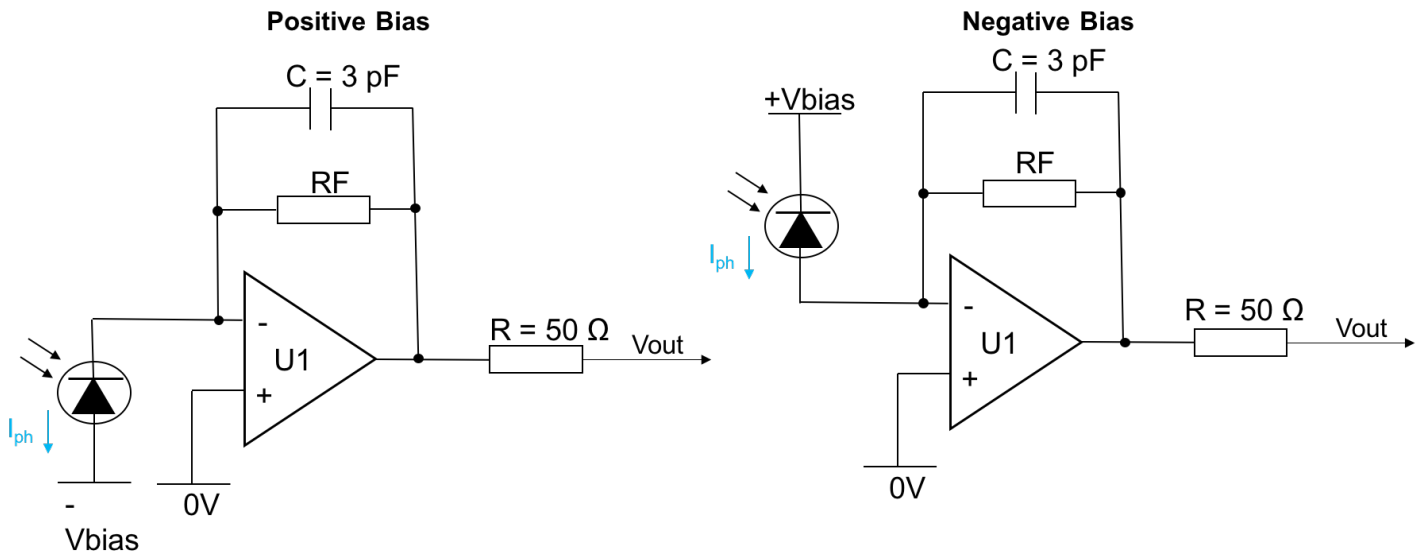


Figure 12, Standard readout of the SiPM using a TIA (transimpedance amplifier)

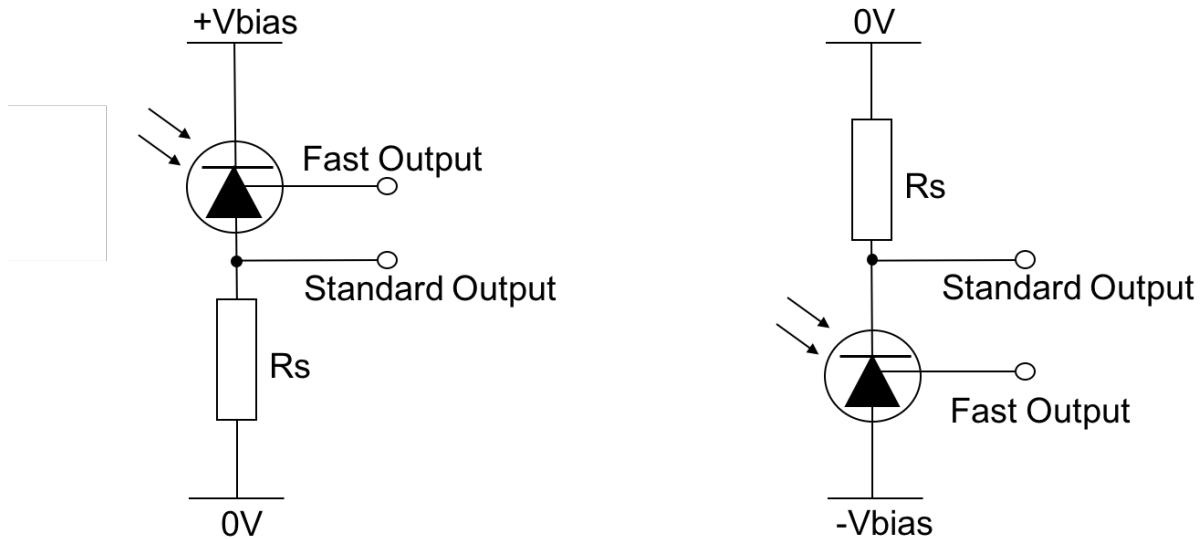


Figure 13, Standard readout using a sense resistor with positive bias (left) and negative bias (right). Typically, $R_s = 50\ \Omega$ for 1 mm, 3 mm and 4 mm SiPMs and $10\ \Omega$ for 6 mm SiPMs.

bandwidth of 1 GHz with a gain of 20 dB is suggested.

Example pulses from the *standard output* are given in Figures 15 - 17.

3.2. Fast Output Readout

To read out the *fast output* the SiPM must be correctly biased as per [Biasing of the SiPM](#) section. No sense resistor is required if the *standard output* is not used and this also results in the best microcell recovery time for the SiPM.

The *fast output* is a voltage pulse that can be read directly into an oscilloscope or digitizer circuit. *Fast output* rise times and pulse widths are of the order 1 ns depending on sensor size. The *fast output* capacitance is much smaller than that of the *standard output* and the values for specific SiPMs can be found in their respective datasheets. Example pulses from the *fast output* are given in Figures 18 - 19.

Optimal *fast output* performance depends on the sensor type.

- P-on-N sensors are optimally biased with a negative voltage on the *anode*, and the *cathode* (which is the substrate in this case) connected to 0 V.

- For N-on-P sensors a positive bias should be connected to the *cathode* and the *anode* (which is the substrate in this case) should be connected to 0 V.

If the sensor cannot be biased in the optimal way as described above, a 10 nF, 100 V, low ESR decoupling capacitor must be connected between the substrate terminal and 0 V. This provides a high frequency return path to the substrate for the *fast output*, which helps to improve the pulse timing.

For amplification of the *fast output* signal a low noise 50 Ω RF voltage amplifier with a frequency range up to 1 GHz and a gain of 20 dB is recommended. For example Mini-Circuits ZX60-43S+ or Mini-Circuits ZFL-1000LN+ are regularly used in SensL lab. More than one amplifier may be required to provide sufficient gain.

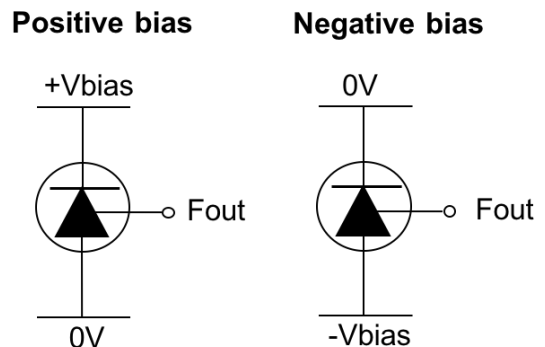


Figure 14, Fast output readout.

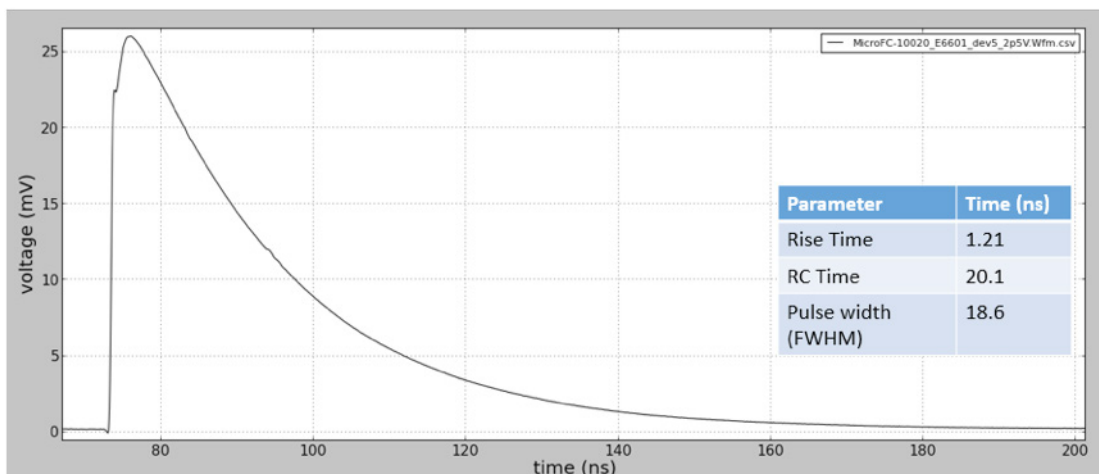


Figure 15, Standard output pulse response of MicroFC-10020 to 420 nm laser with 10 ns pulse width, high of 1.7 V and a low of 0 V. Overvoltage = 5 V. Scope input is 50 Ω . Readout using 50 Ω series resistor on standard output. (SMA Board)

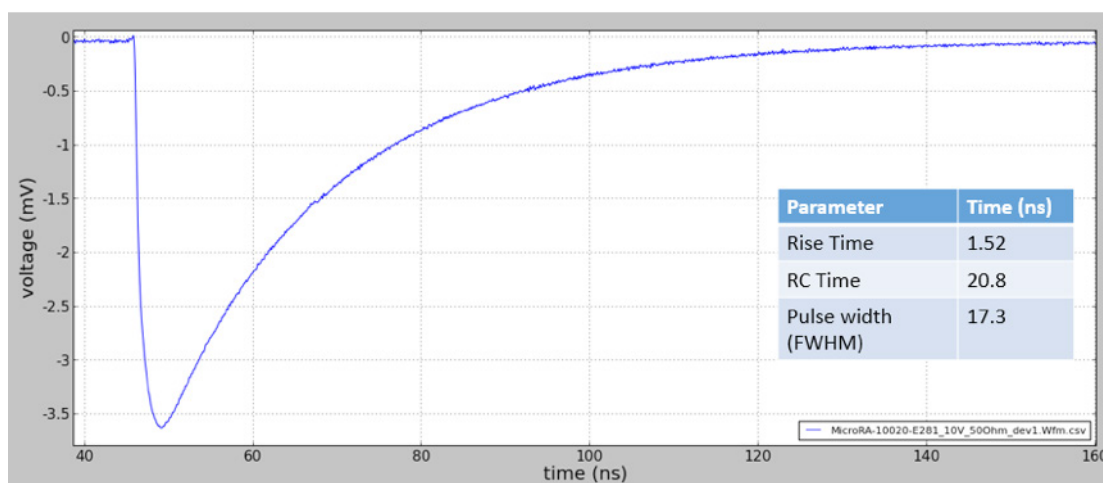


Figure 16, Pulse response of MicroRA-10020 to 905 nm laser with 10 ns pulse width, high of 1.7 V and a low of 0 V. Overvoltage = 10 V. Scope input is 50 Ω . Readout using 50 Ω series resistor on standard output. (SMA Board)

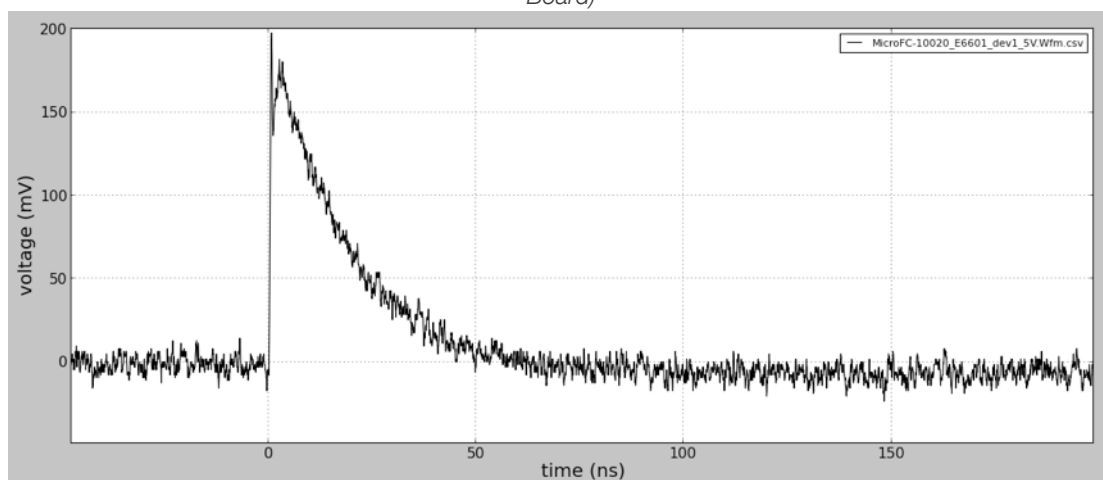


Figure 17, MicroFC-10020 dark pulse shape. Readout on standard output with 50 Ω series resistor connected to 2 x ZX60-43S+ amplifiers in series. Overvoltage = 5 V.

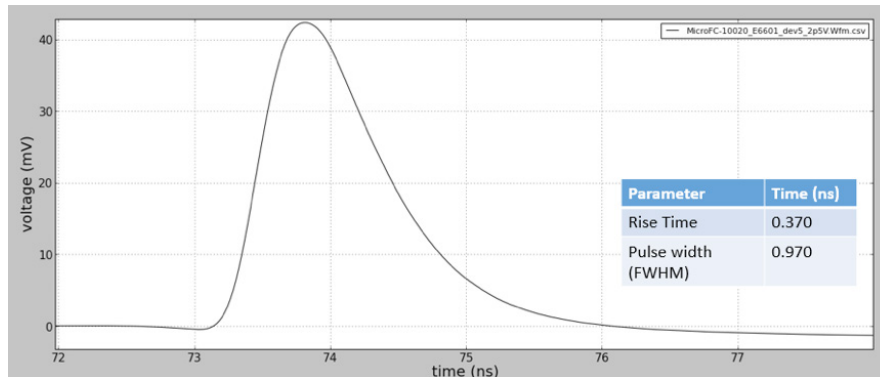


Figure 18, Fast output pulse response of MicroFC-10020 to 420 nm laser with 10 ns pulse width, high of 1.7 V and a low of 0 V. Overvoltage = 5 V. Scope input is 50 Ω . Readout with direct connection to oscilloscope.

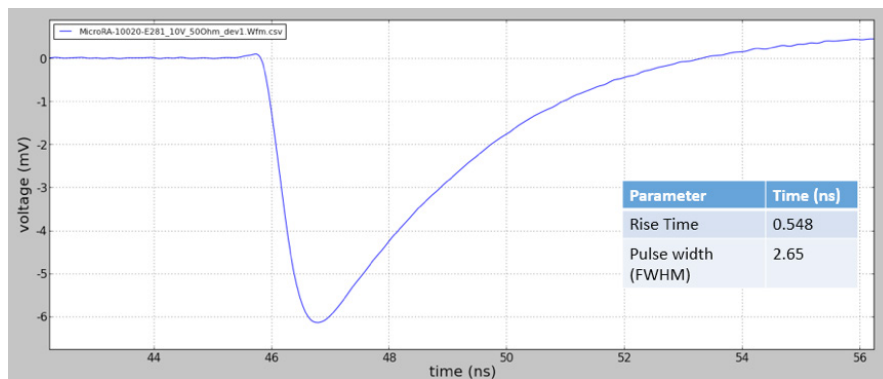


Figure 19, Fast output pulse response of MicroRA-10020 to 905 nm laser with 10 ns pulse width, high of 1.7 V and a low of 0 V. Overvoltage = 10 V. Scope input is 50 Ω . Readout with direct connection to oscilloscope

4. Dual Readout Considerations

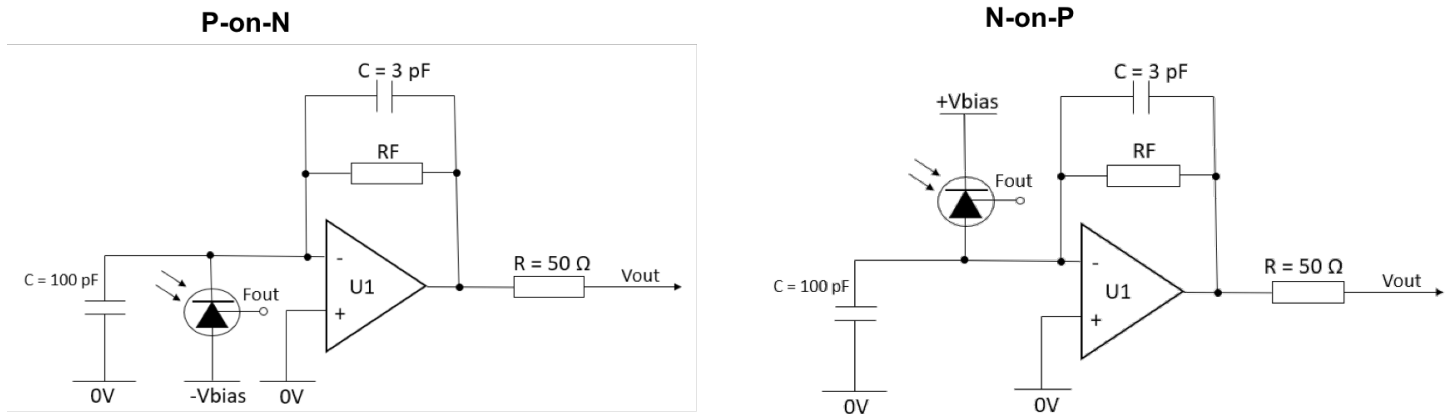
For dual readout cases, where a TIA is being used to read out the *standard output* there are two instances where a 100 V, low ESR, 100 pF capacitor should be used. See Figure 20. This capacitor provides the high frequency return path for the *fast output* when the SiPM is connected to a virtual ground while not affecting the stability of the TIA.

- For P-on-N structures the capacitor is used when a negative bias is connected to the *anode* and the *cathode* is connected to the virtual ground.
- For N-on-P structures the capacitor is used when the *cathode* is connected to a positive bias and the *anode* is connected to virtual ground.

5. Array Readout

Many applications require the use of multiple sensors in the form of an array, such as the SensL Array products. Large arrays can pose a readout challenge due to the many channels of amplification and processing that are required. Therefore, methods of reducing the number of channels are often employed to reduce the readout requirements. Many examples of this can be found in the literature and from specialist suppliers.

Further details can be found in the [Array Readout Tech Note](#).



$R_F = 2k2 \Omega$ (1 mm sensor) or 470Ω (3 mm, 4 mm, and 6 mm sensor)
 $U1 = OPA656$

Figure 20, Dual readout cases where a 100 pF capacitor must be used

6. Series Resistance and Microcell Recovery Time

The microcell recovery time is a measure of the time taken for a microcell to return to its normal (ready) state following a detection event and is a function of the total number of microcells, the microcell capacitance and resistance and the series resistance of the circuit.

$$\tau_R = C_{\mu cell} (R_Q + N \cdot R_S)$$

Where:

τ_R = recovery time constant

$C_{\mu cell}$ = microcell capacitance

R_Q = quench resistance

N = number of microcells in the SiPM

R_S = series resistance

In addition note that the 90% to 10 % microcell recovery time:

$$T_{90\%-10\%} = 2.2 \tau_R$$

As can be seen in the equation the series resistance is multiplied by the number of microcells affects the microcell RC time constant. The series resistance

includes any parasitic resistances that may be present in the PCB traces on the *cathode* and the *anode*. The series resistance R_S should be kept as small as possible to optimize the SiPM recovery time. For this reason, it may be necessary to exclude the SensL recommended bias filter, particularly for larger SiPMs or for arrays of SiPMs when short recovery time is required.

Please see SensL's [SiPM Linearity Tech Note](#) for more details.

7. Impedance Matching

Due to the fast rising edge on both *fast* and *standard outputs*, care should be taken in the routing of the signal to maintain good signal integrity. Common microwave/ RF design rules, such as controlled impedance microstrip lines, may be used.

When driving an amplifier on a PCB it is recommended to keep the distance between SiPM and amplifier as short as possible to ensure there will not be any reflections along the trace.

The SensL SMA evaluation board is intended to drive long cables and in this scenario impedance matching is necessary to avoid reflections. The *standard output*

is terminated with an appropriate resistor to provide reasonably good impedance matching and good signal performance. The capacitance of the *fast output* is much lower (of the order of 2-3 pF for a 1 mm device) than the *anode-cathode* capacitance. For 1 mm devices the capacitance is low enough to allow direct 50 Ω connection even through a long cable. Devices larger than 1 mm have higher capacitance and signal integrity will be less optimal in such a scenario. For larger SiPMs SensL uses the RFXF9503 balun, which is connected on the SMA board as in Figure 21 to set up a 50 Ω impedance at the *fast output*. This provides optimal *fast output* pulse amplitude and timing characteristics when used with a 50 Ω cable and 50 Ω scope termination. The balun is not required for application specific circuits.

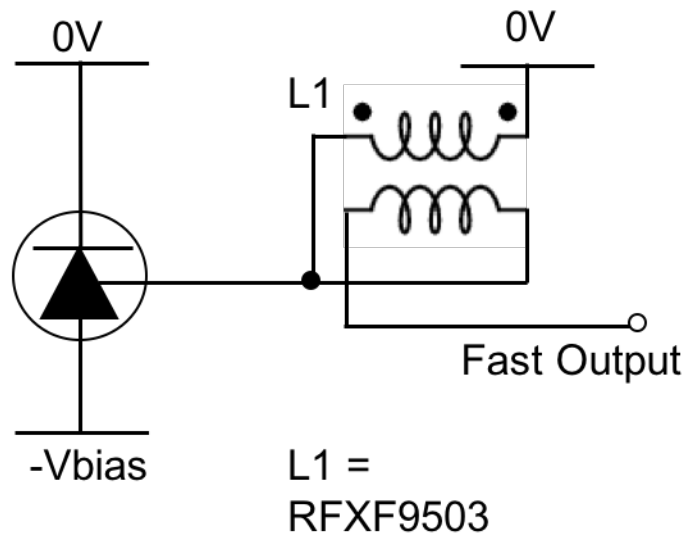


Figure 21, Impedance matching circuitry that can be used with 3 mm and 6 mm sensors when driving signals through a long trace or cable

8. Layout Guidelines

Best practices for PCB design should be followed when creating custom PCBs using SensL SiPMs. Attention should be paid to the following items for best performance.

Use power/ground planes to help with providing a low impedance supply to the SiPM. This becomes more important with larger areas of arrays. Decoupling capacitors should be placed as close as possible to the Vbias terminal (*anode* or *cathode*) and amplifiers where used should be placed as close as possible to the signal terminal to maintain good signal integrity.

Power and ground planes also provide parasitic power supply decoupling.

High speed layout techniques should be employed for optimum results, especially when using the *fast output*, which can have a rise time as fast as 300 ps. For best results short, wide, matched impedance traces are recommended to reduce inductance.

It is advisable to consider thermal effects and employ efficient heatsinking to minimize temperature rise due to photocurrent in the SiPM. NC pins in the SiPMs are not electrically connected and connection to a plane is not necessary for signal integrity, however connecting NC pins to a plane helps with heat dissipation by providing a thermal path from the SiPM package to the copper plane.